

深圳市索瑞达电子有限公司

承 认 书 SPECIFICATION FOR APPROVAL

客户名称: Customer Name:	YHT	
客户料号: Customer P/N:		
产 品 名 称 : Product Name:	功率电感	
索瑞达料号: Sorede P/N:	SDRH1207LF-101M	

制造厂商				
Manuf	acturer			
拟 制	一类小 香			
Draft	識达电子有 _阻			
审核				
Check	程专用管妃园			
日期	2021 02 16			
Date	2021-03-16			



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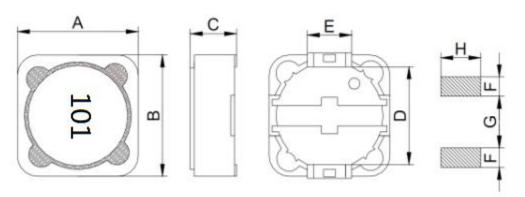
修改履历表

Modify Resume

修改日期			修改明细	修改后版本号
Date modified			Modify Details	Version No.
2021-03-16	文件新制订	File formulation		A

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1、外形尺寸 Dimension:



单位Unit: mm

A	12.0±0.3
В	12.0±0.3
C	8.0Max.
D	7.6 Ref
Е	5.0 Ref
F	2.9 Ref
G	7.0 Ref
Н	5.4 Ref

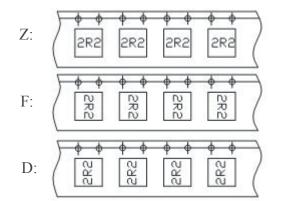
2、产品品名构成 Product Spec. Model

- a: 系列名称Series name
- b: 产品尺寸Product dimensions (AxBxC)
- c: 密封方式Sealing way (L: 冷封Cold seal Y: 热封Heat seal)
- d: 印字方向 Lettering direction ▶
- e: 电感值Inductance Value

(1R0:1.0uH; 100: 10uH; 101:100uH)

f: 电感公差Inductance Tolerance (K:10%; M:20%; N:30%)

► Lettering direction



3、材料清单MATERIAL LIST

NO.	PARTS	MATERIAL	UL FILE NO.	TEMP. CLASS
1	CORE	FERRITE OR EQUIVALENT	NA	NA
2	WIRE	POLYURETHANE ENAMELLED COPPER WIRE OR EQUIVALENT	E258243	180℃
3	ADHESIVE	Epoxy OR EQUIVALENT	NA	NA
4	BASE	C5191 OR EQUIVALENT	NA	NA
5	SOLDER	Sn99.3-Cu0.7 OR EQUIVALENT	NA	NA

^{*}NA:NOT APPLICABLE.

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4、电性能参数表 Electrical Characteristics List

品升电流 frms (A)
1.20

※公差Tolerance: N:±30%、M:±20%、K:±10%.

※工作温度Operating temperature rang: -40 $^{\circ}$ to +105 $^{\circ}$ (Including Self-heating)

※储存温度Storage termperature rang: -40 ℃ to +105℃

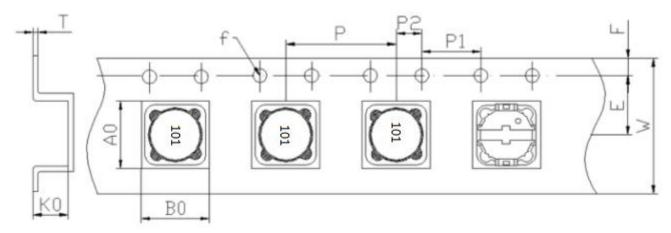
额定电流: 指使电感量比初始值下降25%.或电感器表面温度上升40℃.的电流值(参考周围环境温度25℃)。

The rated DC current is that which cause at 25%.inductance reduction from the initial value or inductor surface temperature to rise by 40° C., whichever is smaller (Reference ambient temperature 25° C).

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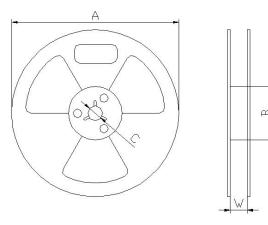
5、产品包装 Packaging

1) 载带包装示意图 Tape packing diagram



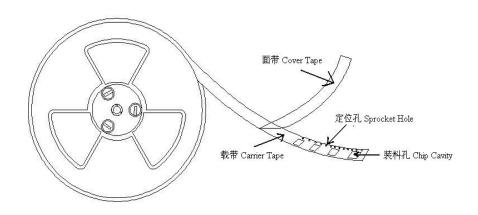
ITEM	W	A0	В0	K0	P	Е	F	D0	P0	P2	T
DIM	24.0	12.6	12.6	9.0	16.00	11.5	1.75	1.50	4.00	2.00	0.40
TOLE	±0.3	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1	+0.1	±0.1	±0.1	±0.05

2)卷盘尺寸 REEL DIMENSION(mm)



А	330±0.5
В	100±0.5
С	13.5±0.5
W	24.5±0.5

3) 卷盘包装示意图 Tape packing diagram

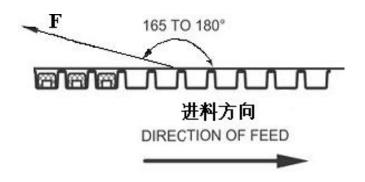


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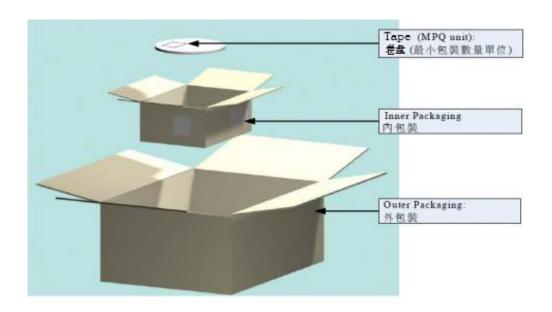
4)剥离强度要求Peeling required

①F 力大小: 20~100g;

②面带剥离角度: 165°~180°。



5) 包装数量 Packing quantity



项目 (Project)	数量(PCS)	尺寸规格(Size:mm)
盘(Reel)	500	13"
内盒 (Inner box)	1000	340mm*340mm*65mm
外箱 (Out box)	3000	360mm*360mm*225mm

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6.RELIABILITY TEST METHOD										
MECHANICA	L									
TESTITEM	SPECIFICATION	ATION TEST DETAILS								
Substrate bendir	△L/Lo≦±5%	The sam	ple shall be soldered onto	the printed c	ircuit board					
		in figure	n figure 1 and a load applied unitil the figure in the arrow							
	There shall be	direction	is made approximately 3	mm.(keep tim	ne 30 seconds)					
	no mechanical	PCB din	nension shall the page 7/9							
	damage or elec-		F(Pressu	urization)						
	trical damege.		Г							
			·	<u>,</u>						
			R5 45±2	45±2						
		10/20								
	PRESSURE ROD									
figure-1 R340										
Vibration	△L/Lo≦±5%	The sample shall be soldered onto the printed circuit board								
		and whe	en a vibration having an an	nplitude of 1.5	52mm					
	There shall be	and a frequency of from 10 to 55Hz/1 minute repeated should								
	no mechanical	be appli	ied to the 3 directions (X,Y	,Z) for 2 hour	s each.					
damage. (A total of 6 hours)										
Solderability	New solder	Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated								
	More than 90%	over the whole of the sample before hard, the sample shall								
		then be preheated for about 2 minutes in a temperature of								
		130∼150°C and after it has been immersed to a depth 0.5mm below for 3±0.2 seconds fully in molten solder M705 with								
		a tempe	rature of 245±2 $^\!$							
		More that	an 90% of the electrode se	ections shall k	oe couered					
		with new	solder smoothly when the	e sample is ta	aken out of					
		the sold	er bath.							

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MECHANICAL									
TESTITEM		SPECIFICA	ЛОП						
Resistance to	There shall be	Temperat	ure profile of r	eflow soldering					
Soldering heat	no damage or								
(reflow soldering)	problems.	So 50 150	Peak tempera heating -heating 2 min	(Sto tempor					
		The specimen shall be passed through the reflow oven with the							
	condition shown in the above profile for 1 time.								
		The specimen shall be stored at standard atmospheric conditions							

ELECTRICAL

TESTITEM	SPECIFICATION	TEST DETAILS
Insulation	There shall be no other	DC 100V voltage shall be applied across this sample of top
resistance	damage or problems.	surface and the terminal.
		The insulation resistance shall be more than $1 \times 10^8 \Omega$.
Dielectric	There shall be	AC 100V voltage shall be applied for 1 minute acrosset the top
withstand	no other	surface and the terminal of this sample
voltage	damage or	
	problems.	
Temperature	△L/L20°C ≦±10%	The test shall be performed after the sample has stabilized in
characteristics	0~2000 ppm/℃	an ambient temperature of - 40 to + 125 $^\!$
		calculated based on the value applicable in a normal
		temperature and narmal humidity shall be △L/L 20°C ≦± 10%.

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ENVIROMEI	NT CHARAC	CTERI	STIC	S				
TESTITEM	SPECIFICATION							
High temperature	△L/Lo≦±5%	The sample shall be left for 500 hours in an atmospere with						
storage		a tempe	a temperature of 105±2℃ and a normal humidity.					
	There shall be	Upon co	mpletio	n of the measurement sha	all be made after	the		
	no mechanical	sample	has bee	en left in a normal tempera	ture and normal			
	damage.	humidity	for 1 h	our.				
Low temperature	△L/Lo≦±5%	The sam	ple sha	ll be left for 500 hours in a	an atmosphere wi	th		
storage		a tempe	rature o	f -40±3℃ .				
	There shall be	Upon co	mpletio	n of the test, the measure	ement shall be ma	ade		
	no mechanical	after the	sample	e has been left in a norma	I temperature and			
	damage.	normal h	numidity	for 1 hour.				
Change of	△L/Lo≦±5%	The sam	The sample shall be subject to 5 continuos cycles, such as shown					
emperature		in the ta	ble 2 be	elow and then it shall be s	ubjected to stand	ard		
	There shall be	stmosph	neric co	nditions for 1 hour, after w	hich measureme	nt		
	no other dama-	shall be	made.					
	ge of problems							
			table 2					
			Temperature Duration					
			1	−40±3 °C	10 m	in.		
				(Themostat No.1)				
			2	Standard	5 sec. c	or less		
				atmospheric	No.1→	No.2		
			3	105±2 ℃	30 m	in.		
				(Themostat No.2)				
			4	Standard	5 sec. o	or less		
				atmospheric	No.2→	No.1		
Moisuture storage	∴L/Lo≦±5%	The sam	nple sha	all be left for 500 hours in a	a temperature of			
			•	umidity (RH) of 90 \sim 95% .				
	There shall be			n of the test, the measure	ement shall be ma	ade		
	no mechanical		•	e has been left in a norma				
	damage.			more than 1 hour.				
Test conditions :								
				the printed circuit board in				

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8、注意事项 Note

①本承认书保证我司产品作为一个单体时的质量情况。当我司产品被安装到贵司产品上时,请保证 贵司的产品已根据贵司的规范进行了有效评估和确认。

This product specification guarantees the quality of our product as a single unit. Please make sure that your product is evaluated and confirmed against your specifications when our product is mounted to your product.

②如果贵司对我司产品的使用已超过了本承认书所界定的产品功能,那么对于由此引发的失效, 我司将不予保证。

We cannot warrant against failure caused by any use of our product that deviates from the intended use as described in this product specification.

- ③为了保持终端电极的焊接性,并使包装材料保持良好状态,必须控制储存区的温度和湿度。
 To maintain the solderabilty of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled.
 - ※建议的条件: -10~+40℃, 30~70%RH。

Recommended conditions: $-10^{\circ} + 40^{\circ}$ C, $30 \sim 70^{\circ}$ RH.

- ※储存超过六个月的,应在实际使用前进行焊接检验。 In case of storage over 6 months, soldrability shall be checked before actual usage.
- ※即使在理想的储存条件下,产品的可焊性也随着时间的推移而降低。因此,产品应从交货时算起, 建议8个月之内使用完。

Even under ideal storage conditions, the weldability of the product decreases over time. therefore, the product should be From the time of delivery, it is recommended that it be used within 8 months.

④本承认书在客户收到30天之内,必须签章返回,逾期视为默认。

The Specification Approval should be sent back to the supplier with customer's chop on it within 30 days after receiving it, or we will take it as approved by customer's automatically.

⑤如有特殊规格要求,请事前联络我司技术部人员。

In case of special specifications please contact our technical department prior staff.